




Follow up on the Helmholtz Validation Fund "MicroTCA.4 for Industry"

and workshop organization



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MSK, DESY
DESY, 09.12.2015

- Nov. 2005: Reliability Workshop in Grömitz, Germany
 - Joint meeting with ILC (intern. linear collider, 33km, 500GeV)
- Dec. 2007: European XFEL Crate-Standard Workshop
 - MicroTCA and ATCA was defined to be used
- Mar. 2009: First PICMG Meeting “xTCA for Physics” 
 - Hardware group: rear I/O and timing
 - Software group: standardization of interfaces for FPGAs...OPsys
- Oct. 2011: Official announcement of PICMG Specification 
 - “MTCA.4 Enhancements for Rear I/O and Precision Timing“
- Jul. 2012: Start of Helmholtz Validation Fund till Dec. 2014
 - „MicroTCA.4 for Industry“
- Jan. 2014: Reestablish HW/SW PICMG working groups → R. Larsen, SLAC 
- 2015-16: Production / Installation of MicroTCA controls for European XFEL

What is the HGF validation fund?

- Finance instrument to support the spin-off and technology transfer from scientific, technical inventions or developments from HGF centers to the industry and society



Main objectives of “MicroTCA for Industry” project:

Establish MicroTCA.4 electron crate system

- In accelerator community
- Industrial branches
- Scientific community

by reducing the market entry barriers and foster MTCA.4 to industry

Boundaries: 4 Mio (50% HGF) max 2 years, HVF0016: 07/2012 – 12/2014 **successfully**



+ 6 new partners



AP1: Industrialize modules of the RF control system

AP1.1 Revision of existing modules

- AP 1.1.1 Field Detection (uDWC)*
- AP 1.1.2 Controller (uTC)*
- AP 1.1.3 RF driver unit (uVM)*
- AP 1.1.4 Local RF-Generation (uLOG)*

AP1.2 Cost opt. for Single Cavities Applications

- AP 1.2.1 Field detector with RF driver (uDWC-VM)*
- AP 1.2.2 High-end Digitizer (DAQ-LNC)*

AP1.3 Extending Portfolio in Frequency

- AP 1.3.1 Field detector with RF driver (uVM, 0.35-6GHz)*
- AP 1.3.2 Local RF-Generation (uLOG, 0.35-6GHz)*
- AP 1.3.3 RTM with local clock circuit (uCLK-RTM, 10–350MHz)*
- AP 1.3.4 Global clock generation (uCLK-eRTM, 10-350MHz)*

AP1.4 Supplementary systems for RF control

- AP 1.4.1 Multi-channel Direct RF-sampling (uDS800)*
- AP 1.4.2 AMC carrier with motor/RTM with Piezo driver (uFMC20)*

AP1.5 Introduction of RTM-RF Backplane

- AP 1.5.1 Development of RTM-RF Backplane concept*
- AP 1.5.2 Crate integrated RF source (uOSC_eRTM)*

AP2: Completion of MTCA.4 for industry and institutions

AP2.1 Extension of product portfolio for MTCA.4

- AP2.1.1 Industrial production of timing module*
- AP2.1.2 2 GSPS, 4 channel, 12bit ADCs on RTM & AMC*
- AP2.1.3 32 ch., 40MSPS, AMC-RTM with analog shaping capability*
- AP2.1.4 Management low noise power supplies*

AP2.2 EMI optimization and classification of MTCA.4 components

- AP2.2.1 EMI test board development*
- AP2.2.2 EMI current distribution in MTCA.4 crate*
- AP2.2.3 Optimization of crate-contact transitions*
- AP2.2.4 Shields for AMC/RTM boards*
- AP2.2.5 EMI Bypass-concept*
- AP2.2.6 Vibration studies and vibration reduction*
- AP2.2.7 EMI classification of AMC and RTM boards commercially available*
- AP2.2.8 AMC Backplane/connector/board development towards 10Gbit/sec*

AP2.3 Application of MTCA.4 in industry

- AP2.3.1 Integrated klystron life-time and LLRF system*

AP2.4 Evaluation of MTCA.4 market

- AP2.4.1 Market evaluation for industry*
- AP2.4.2 Market evaluation for institutes*
- AP2.4.3 Optional industry order after evaluation*

AP2.5 Integral test of MTCA.4 in large facility, availability, failure analysis

- AP2.5.1 Inter-compatibility of boards/sub-systems, radiation, remote controllability*

- **> 50 sub-projects were carried out and completed**
- **> 40 hardware developments**
- **33 new products were developed suitable for the market:**
 - 24 are available by industry
 - 6 still pending
 - 3 on demand

AP3: Marketing & Support

AP3.1 Support and consultancy

- AP 3.1.1 Continues guidance and consultancy*
- AP 3.1.2 Tutorials*

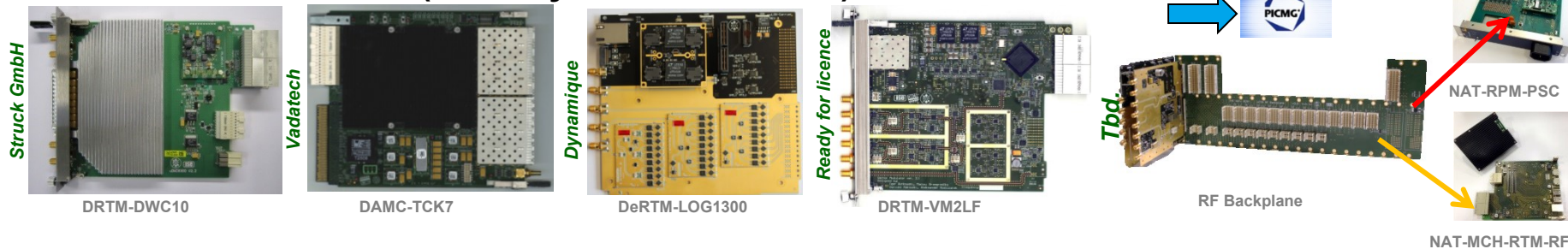
AP3.2 MicroTCA user guide

AP3.3 Marketing and exhibitions

AP3.4 MTCA.4 annual workshop

LLRF controls: rapid portfolio extension was possible through modularity...

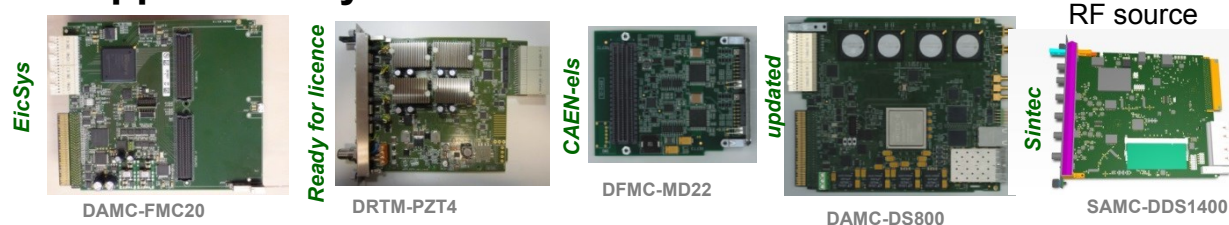
Standard RF Modules (used by FLASH & XFEL)



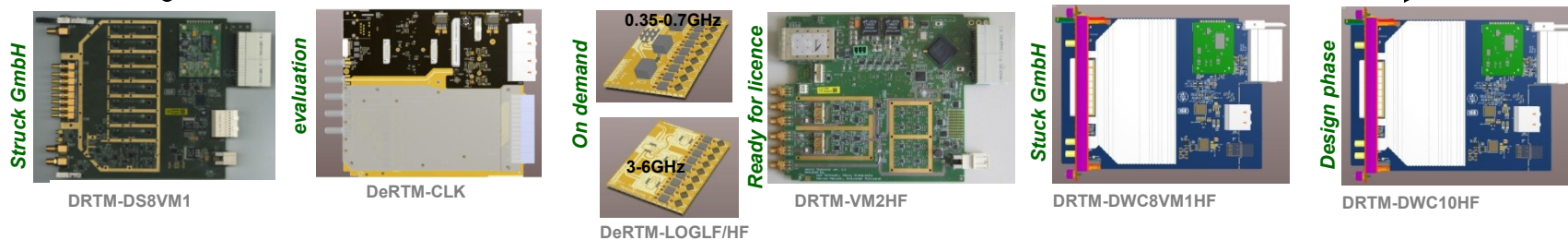
Single cav. extension



Supplementary module extension

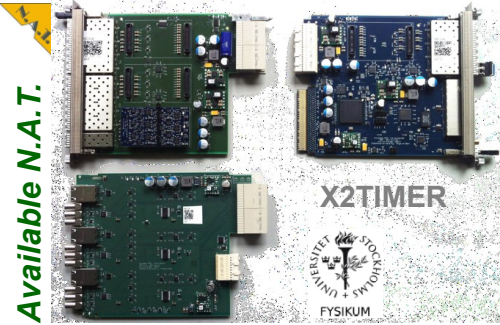


~ MHz ● **Frequency extension** → 6 GHz



2013-2015 through Validation Fund: almost all modules are now available by industry
 2014/15 many improvements w.r.t. performance, features and additional functionalities

ps-timing distribution



Available N.A.T.

RTM_TRIG1

Market entry starter kit (1HE)



Available

High end FMC-carrier / 4ch 1.6GSPS

IC-FEP-TCAa
Virtex-7 FPGA Modul für MTCA.4 Rear-I/O und 2 FMC-Steckplätzen

Available



RTM Shaper - AMC 32 ch ADC 12/14bit

Available



High voltage AMC

HV-Panda CAEN
 Gear For Science

Available



Generic linux driver for MicroTCA

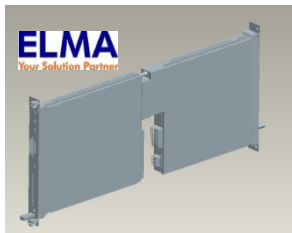
Open source !



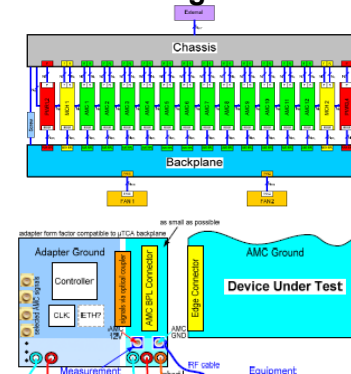
Topics:

- Linux kernel driver & libraries
- Efficient DMA transfer
- Hotplug capability
- Set of test cases
- Test suite for automated driver test
- Redesign of API implementation

EMI/EMC



MicroTCA.4 ground modelling



Requires for quantitative measurements & classification specialized setup!
Project launched: Q2/15

➔ Talk H-H. Ibowski

AP2: missing standards / critical items / open issues / misc. barriers...

➤ Zone 3 Recommendation

Deutsches Elektronen-Synchrotron
Ein Forschungszentrum der Helmholtz-Gemeinschaft

Class D1.0, D1.1, D1.2, D1.3, D1.4

Zone 3 Connector Pin Assignment Recommendation for Digital Applications
for AMC/ μ RTM Boards in the MTCA.4 standard

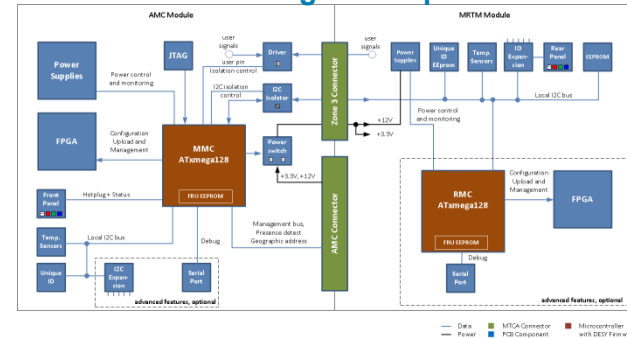
FEATURES

- MTCA.4 management zone:
- Power, I²C, optional JTAG support
- Digital signals in the user zone:

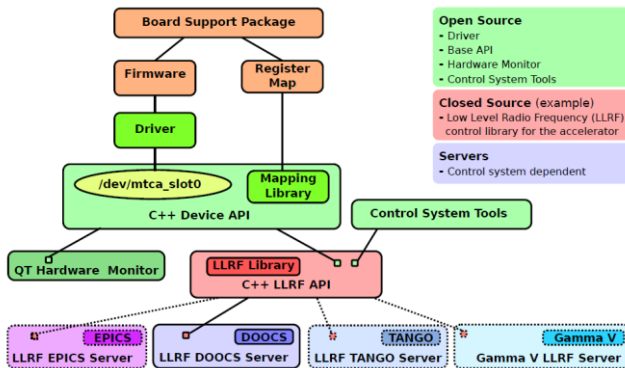
APPLICATIONS

- AMC / μ RTM board design in MTCA.4 standard
- High-speed data processing
- Multi-channel data-converters, sensor readout and output
- Digital signal conditioning boards

➤ MMC Altium designer templates



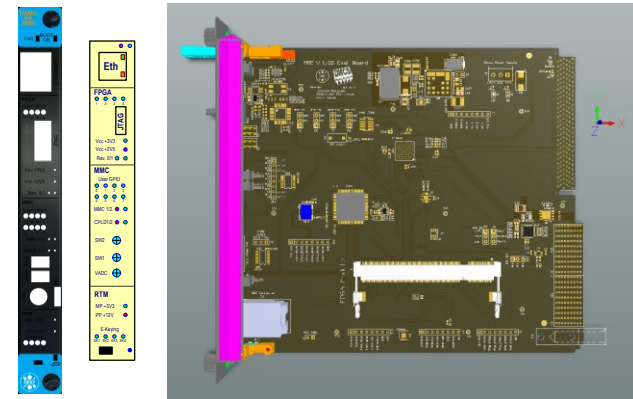
➤ MTCA.4, open software framework



➔ Talk N. Shezhad

➤ Interlock integration....

➤ MMC Starter Kit (AMC/RTM) available



➤ MMC code development



Meanwhile widely adopted...

➤ **MTCA.4 support and consulting**

FAQ/Hotline
Direct support
Tutorial, every 2 month “hands on”

6 in 2013
8 in 2014 (4 advanced)
7 in 2015 (4 advanced)

➤ **MicroTCA.4 Introductory guide**

Booklet published by DESY/NAT: work in progress

➤ **Products marketing & information**

4th MicroTCA.4 workshops (2012-2015)
Marketing on industrial exhibitions/ Face-to-face meetings

28 (+11) in 2013
16 (+16) in 2014
2 (+4) in 2015

➤ **Interoperability / Integration**



- AIW24 Pentair, Straubenhardt @ Nov 2013
- **AIW25 DESY, Hamburg** @ Apr 2014
- AIW26 Vadatech, Henderson @ Oct 2014
- **Integration WS, DESY** @ Dec 2014
- **Integration WS, DESY** @ Dec 2015

MTCA Tutorials at DESY (05/2013) & Shanghai (09/2014)



Embeddedworld 2013 Nürnberg



IPAC 2013 Shanghai



TWEPP 2013 Perugia



European Microwave Week 2013

Webpage URL <http://mtca.desy.de/>

2015 DESY Directorate approved funding to continue **“MicroTCA” @ DESY**

Activities (strongly reduced compared to HVF):

- Future enlarge MicroTCA product portfolio through licensing
- Continuation PICMG efforts (HW/SW)
- Marketing / support / consultancy
- **Investigate future funding options**

Most promising: Applied to „Helmholtz Innovation Labs” initiative



- Interface between industrial and research centers
- Close interaction between Scientists and Industry & users/customer

Funding: 5 Mio total (50%/50%)/ 5 years!

Target of submit application:

- Service & Support
- Creation of set of turn key system

Decision taking: Q1-Q2/2016

Fördermaßnahme „Helmholtz Innovation Labs“
Werkzeug 1 – Ziele und Fallstudiensammlung

Martin Kamprath Stand: 20.07.2015 - Für den internen Gebrauch



- Follow to HVF Consortium was discussed
- Tuned out to be challenging due to personal constrains at DESY

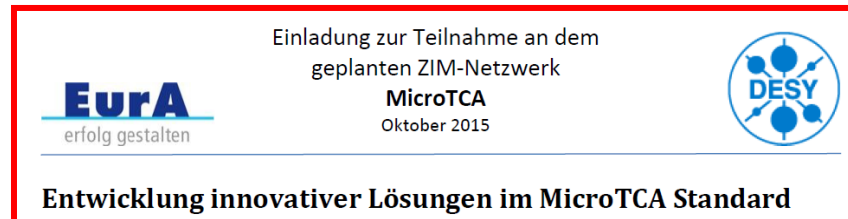
➤ **But:**

Initiated discussion to apply for “ZIM-Cooperation Network”

ZIM = Zentrales Innovationsprogramm Mittelstand

Targeted toward small and medium companies in Germany, but not limited to Germany / KMU’s when sufficient KMU partners joined already

- *Found very competent partner for funding consultancy and managing of a “MicroTCA Cooperation Network”*



- *See booth industrial exhibition → EurA Constance AG*

Workshop organization



Katharina Kull

Monday 07 December 2015

14:00 - 17:00 Integration Workshop

Building 3, BAH1/BAH2

Tuesday 08 December 2015

10:00 - 13:00 Integration Workshop

Building 3, BAH1/BAH2



Michael Fenner



Goal:

Opportunity to test **your application** with vendors on different platform configurations

Well received,

> 20 participants

➔ Will be continued next year

Tuesday 08 December 2015

14:30 - 17:30 Tutorials about MicroTCA.4 given by experts

Building 3, BAH1/BAH2

14:30-15:15 MicroTCA.4 Tutorial Basics

Dietmar Mann, PENTAIR

15:15 – 16:00 MicroTCA Management

Christoph Stechmann, DESY

16:00-16:45 Tutorial about MicroTCA.4

Vollrath Dirksen, N.A.T. GmbH

16:45 – 17:30 MicroTCA and PCI Express and PCI Express Hot Swap under Linux

Ludwig Petrosyan, DESY



Kay Rehlich



Target audience:

Part 1:

- New comers to MicroTCA.4 standard

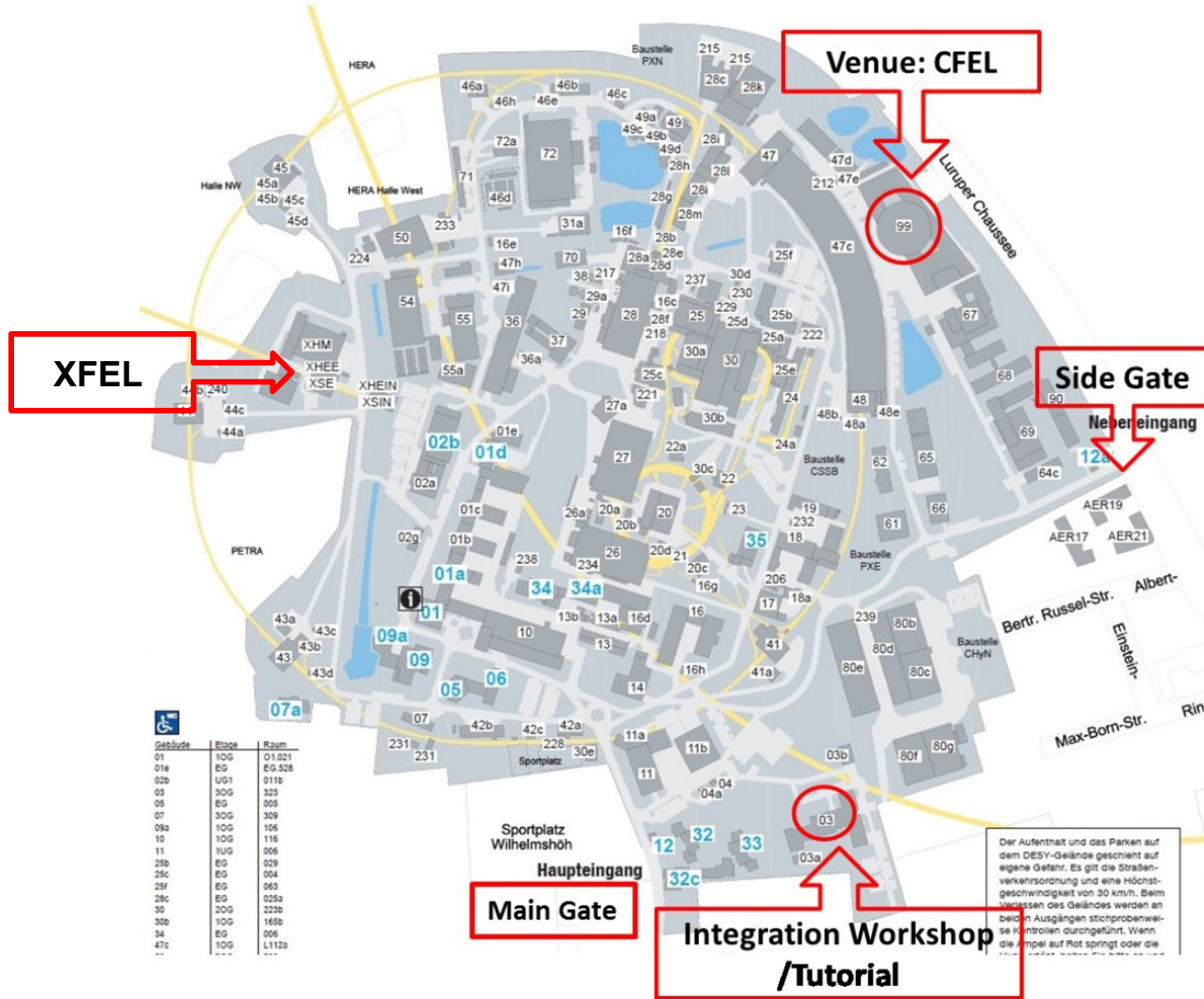
Part 2:

- Advanced users

Well received,

> 50 participants

→ Will be continued next year

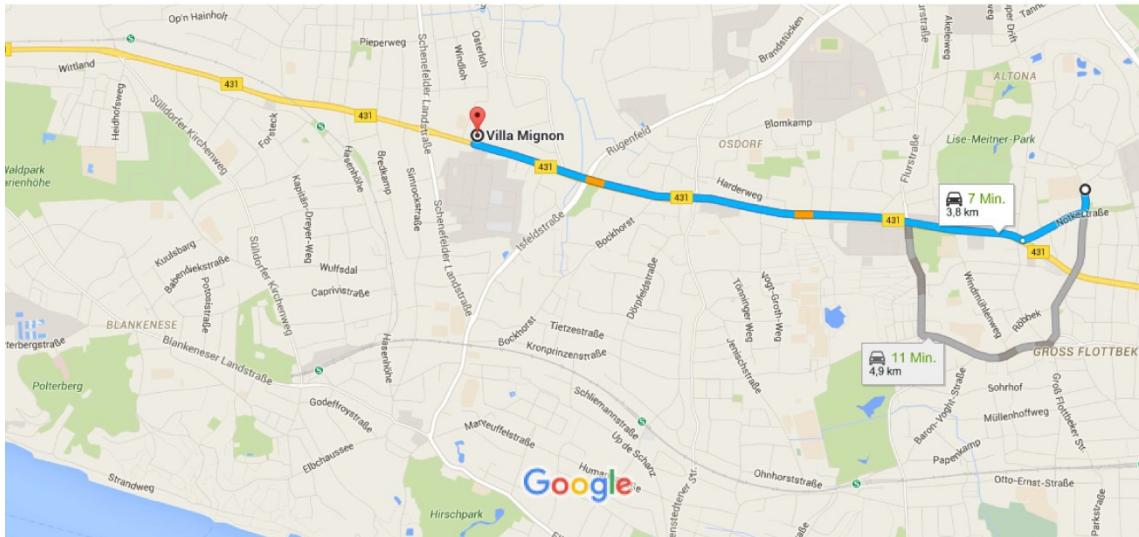


DESY/XFEL tour

- Meeting point → in front of the registration desk
- Takes about an hour
- Guides you to European XFEL facilities



- Wednesday, December 9th in Villa Mignon
- blue dot on your name badge = dinner registration
- Shuttle busses starting from 18:45 in front of CFEL and 18:50 at DESY main gate
- Bring a jacket the reception is outside!
- More information in abstract booklet



WLAN

- Name: **MTCA-Workshop**
- Password: **MTCA-Workshop-2015**

Next Workshop:

7th/8th of Dec. 2016!



**Wish you an informative
and pleasant
4th MTCA Workshop**

Thanks for attention